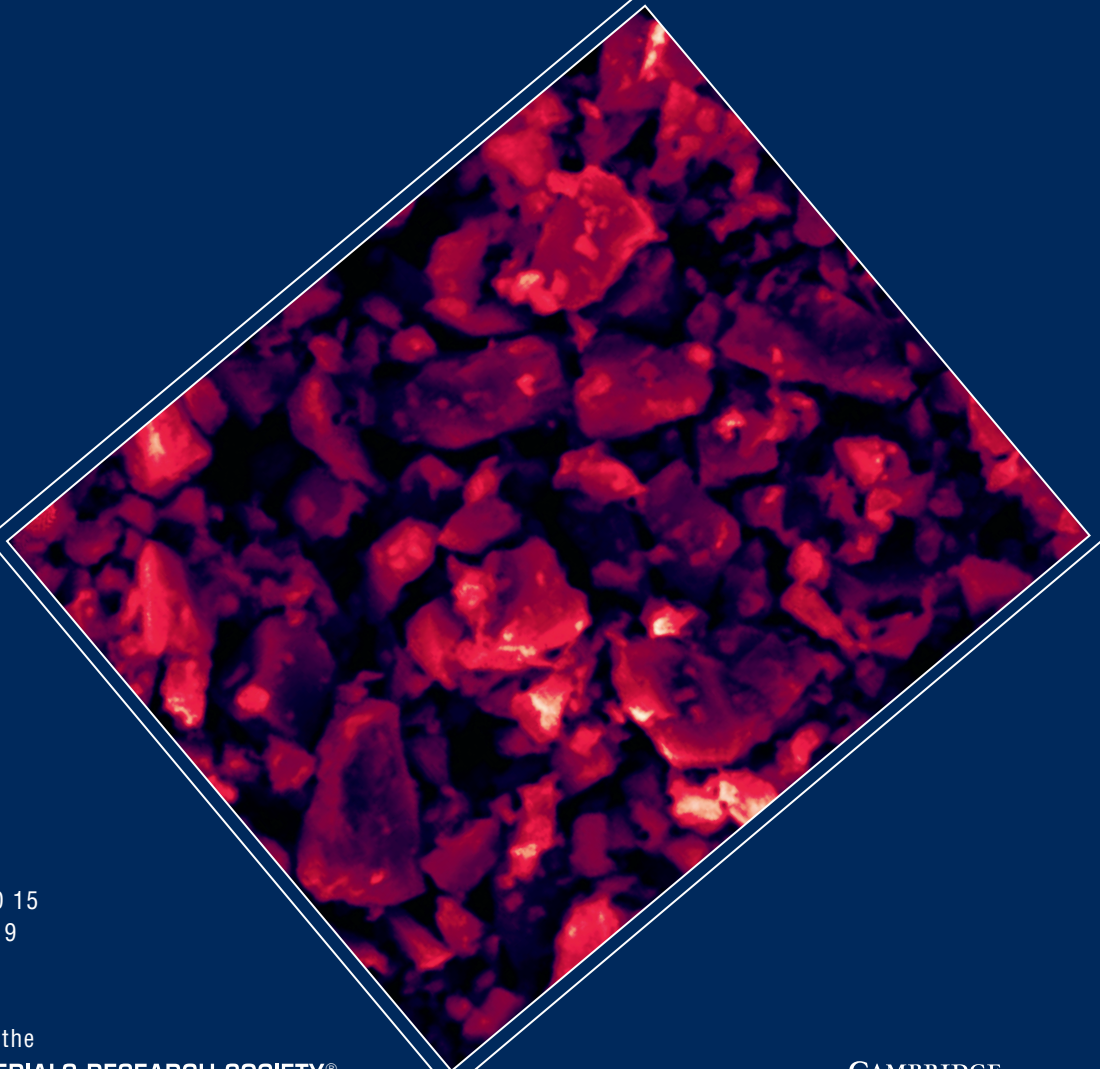




Journal of
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VOLUME 34 • NO 15
AUGUST 14, 2019

A publication of the

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Tapabrata Maity,
Konda Gokuldoss Prashanth,
Alexander Janda, Jeong Tae Kim,
Florian Spieckermann, Jürgen Eckert
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Rathinavelu Sokkalingam,
Veerappan Muthupandi,
Katakam Sivaprasad,
Konda Gokuldoss Prashanth
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Xiaoli Zhao, Lizhan Han, Chuanwei Li,
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Fenggui Lu
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Ruibin Yang, Junrui Yang, Kun Xie,
Zhongxia Liu, Guotao Zhang
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I-Ling Chang, Chin-Chen Hsu,
Ta-Hsiung Chao
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Gaoyong Lin, Weiyuan Song,
Di Feng, Kun Li, Yongping Feng,
Jinxia Liu